

N-Channel Trench Power MOSFET

General Description

The HD80N03 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 5V. This device is suitable for use as a wide variety of applications.

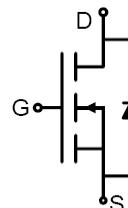
Features

- $V_{DS} = 30V, ID = 70A$
- $R_{DS(ON)} < 6.5 \text{ m}\Omega @ V_{GS} = 10V$
- $R_{DS(ON)} < 8.5 \text{ m}\Omega @ V_{GS} = 5V$
- High Power and current handing capability
- Lead free product is acquired
- Surface Mount Package

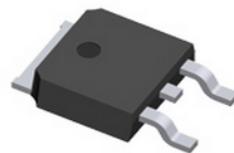
Application

- PWM applications
- Load switch
- Power management

100% UIS TESTED!
100% ΔV_{ds} TESTED!



Schematic Diagram



TO-252(DPAK) top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
HD80N03	HD80N03	TO-252	325mm	16mm	2500

Table 1. Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)

Symbol	Parameter	Value	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	30	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ\text{C}$) <small>(Note 1)</small>	70	A
	Drain Current-Continuous($T_c=100^\circ\text{C}$)	49	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed <small>(Note 2)</small>	230	A
P_D	Maximum Power Dissipation($T_c=25^\circ\text{C}$)	65	W
	Maximum Power Dissipation($T_c=100^\circ\text{C}$)	32.5	W
E_{AS}	Avalanche energy <small>(Note 3)</small>	90	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance,Junction-to-Case	-	2	°C/W

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	30			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =30V, V _{GS} =0V			1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1.0	1.5	2.5	V
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =20A	10	20		S
R _{DSON}	Drain-Source On-State Resistance	V _{GS} =10V, I _D =20A		5	6.5	mΩ
		V _{GS} =5V, I _D =15A		6.5	8.5	mΩ
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} =15V, V _{GS} =0V, f=1.0MHz		2200		pF
C _{oss}	Output Capacitance			312		pF
C _{rss}	Reverse Transfer Capacitance			195		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1.0MHz		2		Ω
Switching Times						
t _{d(on)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =15V, R _L =0.75Ω, R _{GEN} =3Ω		7		nS
t _r	Turn-on Rise Time			22		nS
t _{d(off)}	Turn-Off Delay Time			30		nS
t _f	Turn-Off Fall Time			5		nS
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =25V, I _D =12A		47		nC
Q _{gs}	Gate-Source Charge			8		nC
Q _{gd}	Gate-Drain Charge			9		nC
Source-Drain Diode Characteristics						
I _{SD}	Source-Drain Current(Body Diode)				70	A
V _{SD}	Forward on Voltage	V _{GS} =0V, I _S =20A			1.2	V

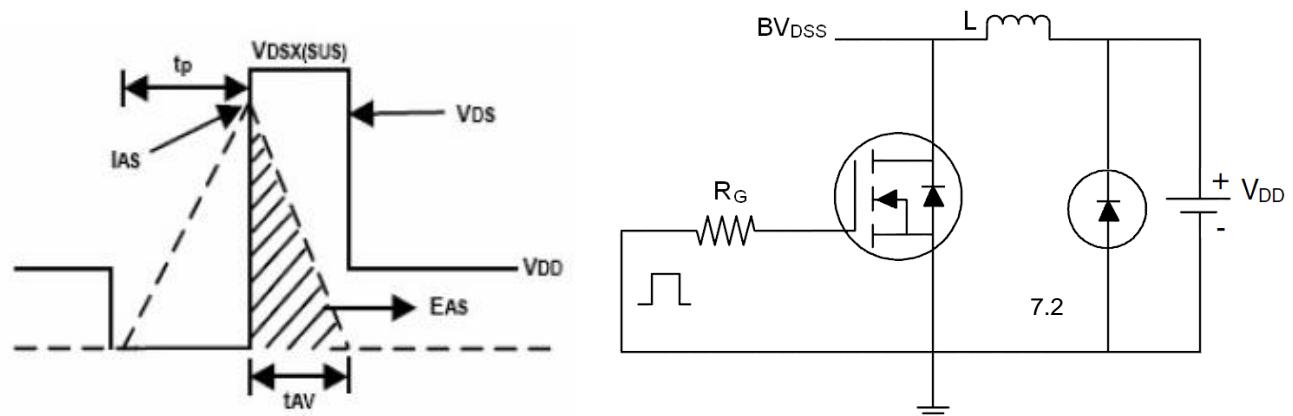
Notes 1.The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

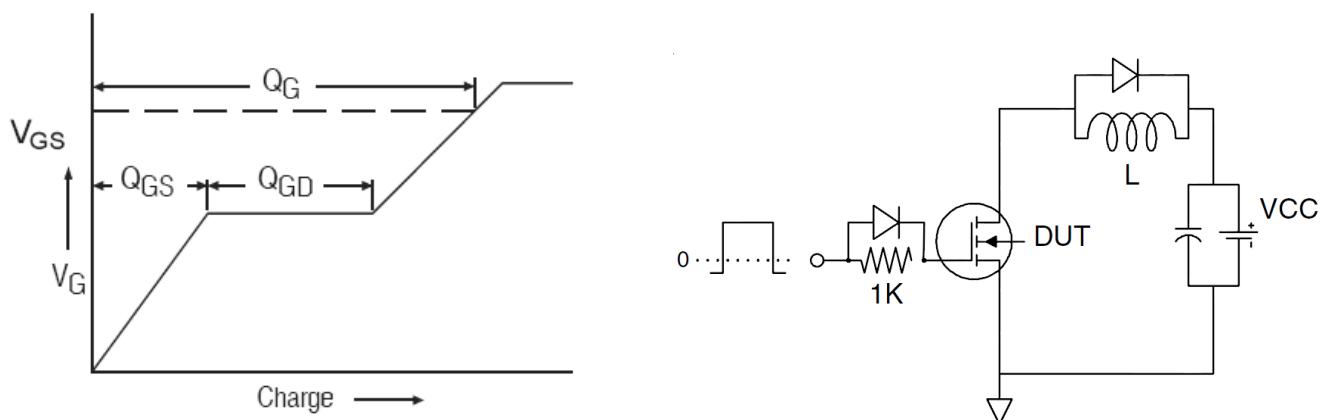
Notes 3.EAS condition: T_J=25°C, V_{DD}=30V, V_G=10V, RG=25Ω

Test Circuit

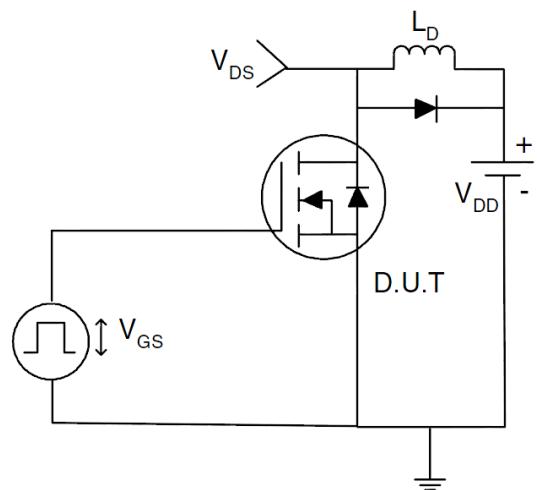
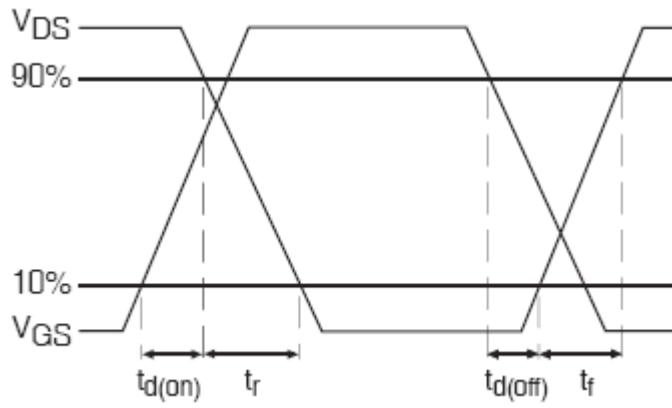
1) E_{AS} Test Circuits



2) Gate Charge Test Circuit:



3) Switch Time Test Circuit:



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

Figure 1. Output Characteristics

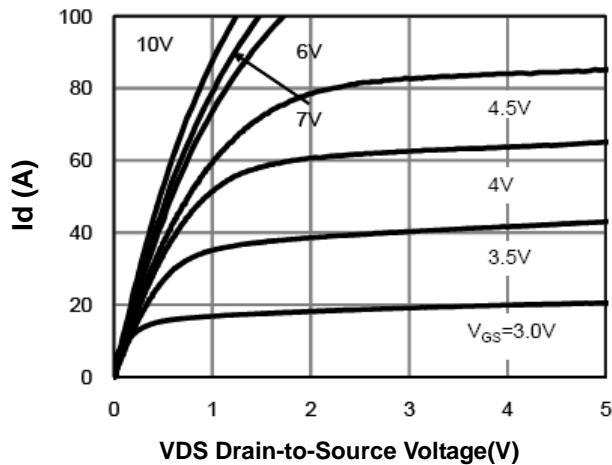


Figure 2. Transfer Characteristics

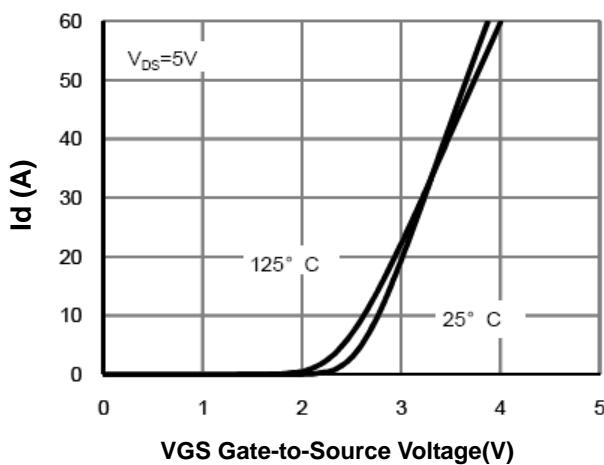
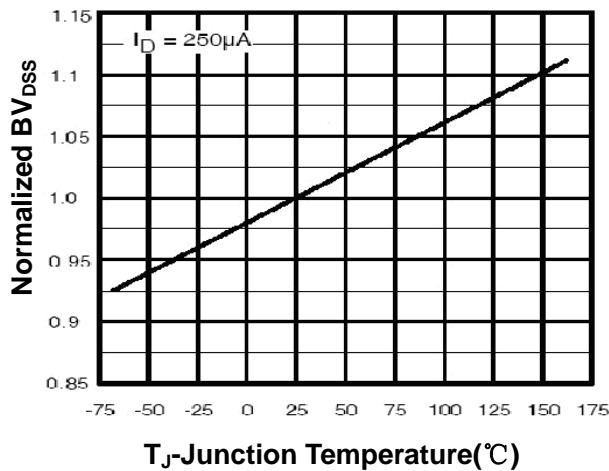

Figure 3. Max BV_{DSS} vs Junction Temperature


Figure 4. Drain Current

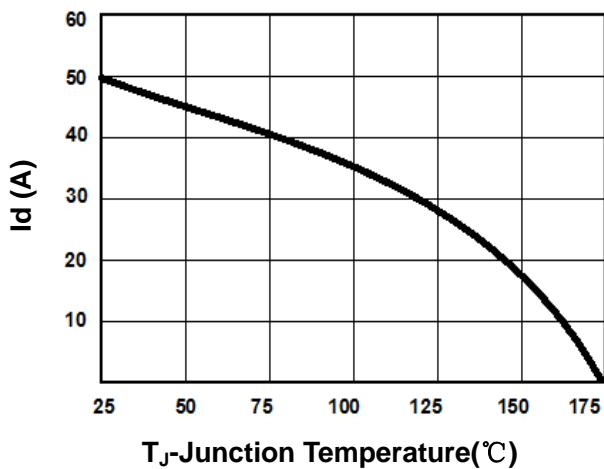
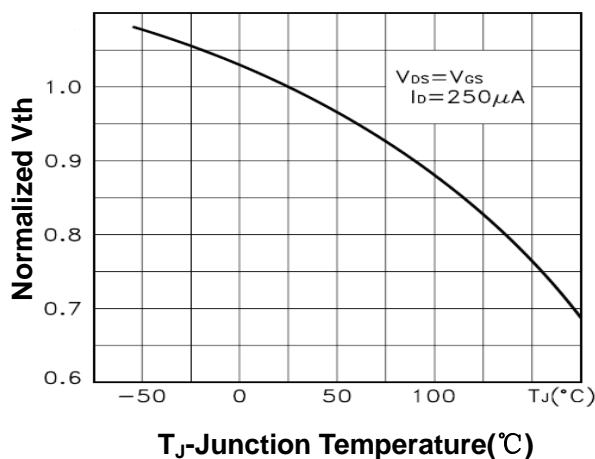
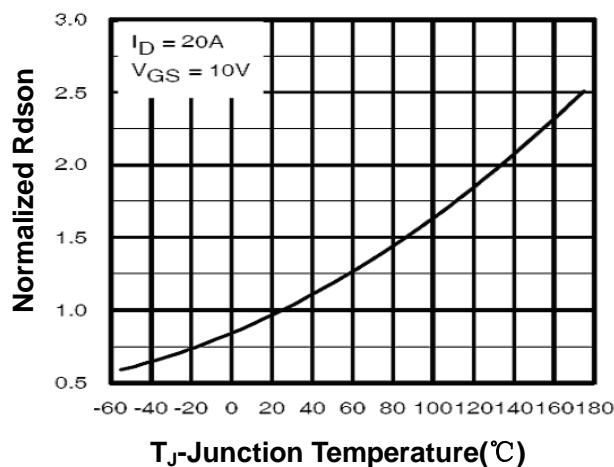

Figure 5. $V_{GS(th)}$ vs Junction Temperature

Figure 6. $R_{DS(ON)}$ vs Junction Temperature


Figure 7. Gate Charge Waveforms

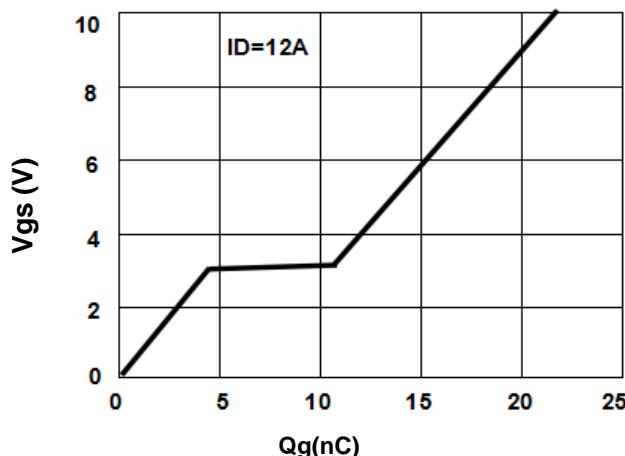


Figure 8. Capacitance

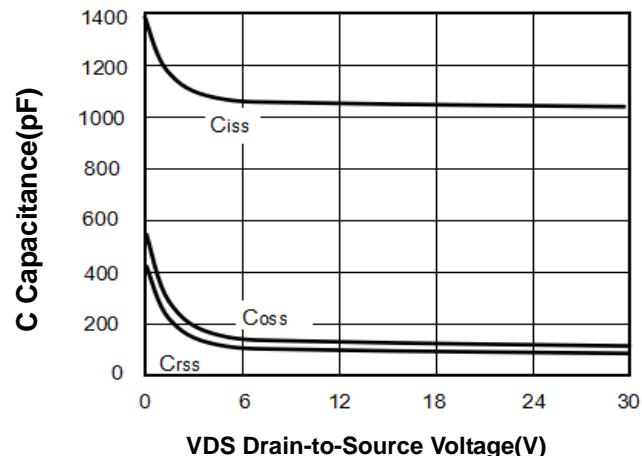


Figure 9. Body-Diode Characteristics

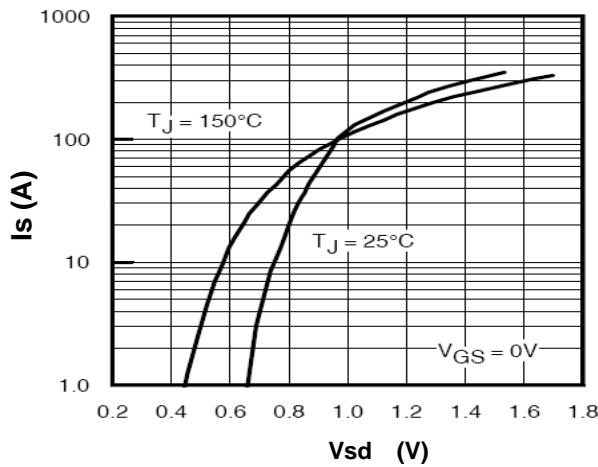


Figure 10. Maximum Safe Operating Area

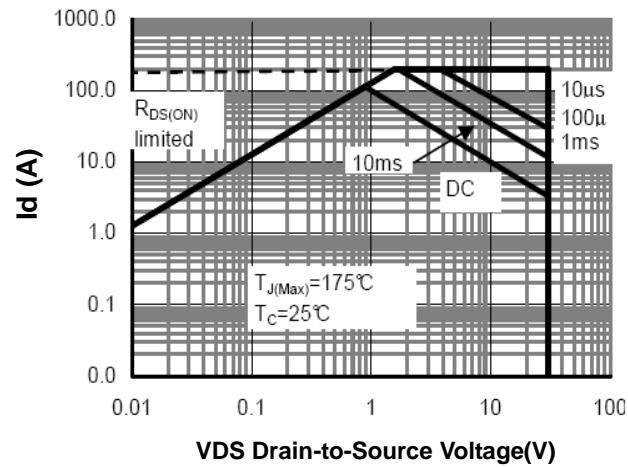
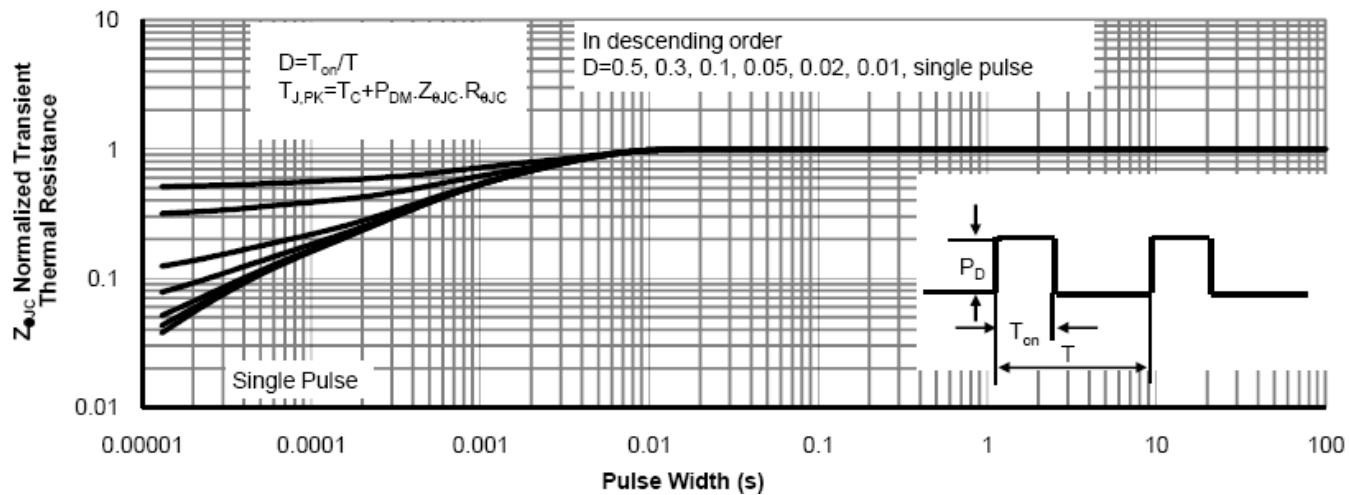
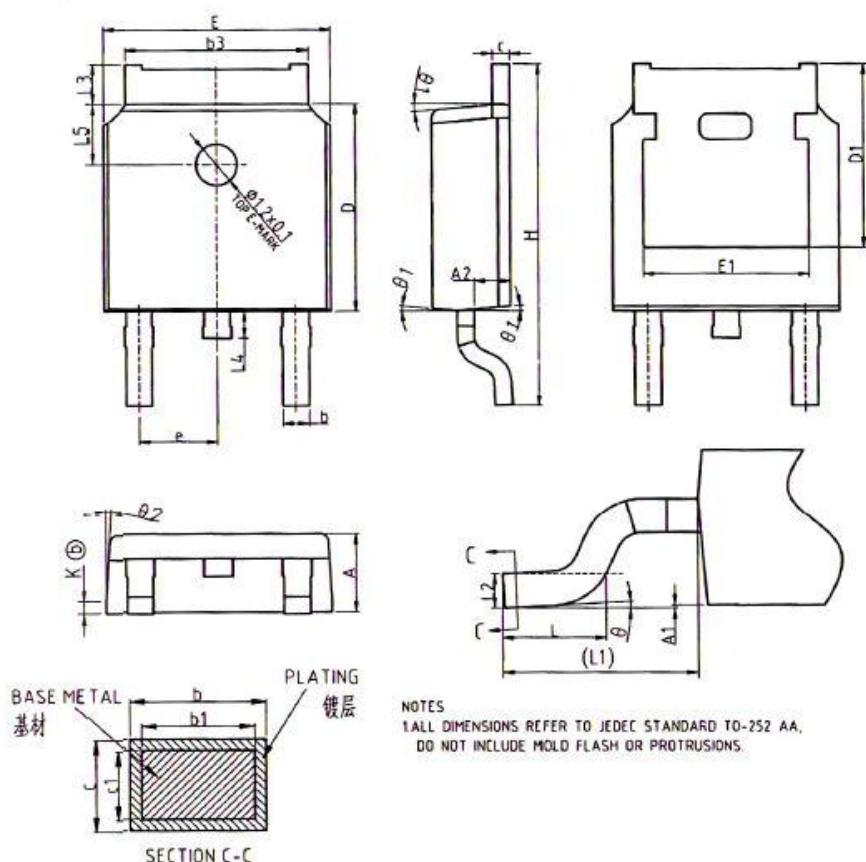


Figure 11. Normalized Maximum Transient Thermal Impedance



TO-252 Package Information



SYMBOL	COMMON DIMENSIONS		
	mm		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0.00	-	0.10
A2	0.97	1.07	1.17
b	0.72	0.78	0.85
b1	0.71	0.76	0.81
b3	5.23	5.33	5.46
c	0.47	0.53	0.58
c1	0.46	0.51	0.56
D	6.00	6.10	6.20
D1	5.30REF		
E	6.50	6.60	6.70
E1	4.70	4.83	4.92
e	2.286BSC		
H	9.90	10.10	10.30
L	1.40	1.50	1.70
L1	2.90REF		
L2	0.518SC		
L3	0.90	-	1.25
L4	0.60	0.80	1.00
L5	1.70	1.80	1.90
θ	0°	-	8°
θ1	5°	7°	9°
θ2	5°	7°	9°
K	0.10REF		